ORIENT DISPLAY

Your Total LCD Solution Provider

http://www.orientdisplay.com

SPECIFICATION
FOR
LCD MODULE

MODULE NO: AFM320240A0-5.7N6NTM
REVISION NO: 00

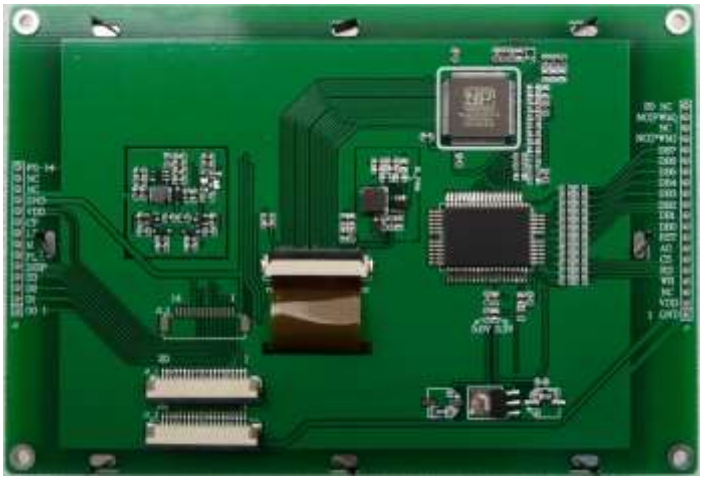
Customer's Approval:

	SIGNATURE	DATE
PREPARED BY (RD ENGINEER)		
CHECKED BY		
APPROVED BY		

CONTENTS

1. Display Characteristic 3
2. Pin Description(J1=J1_1): 3
3. Pin Description(J2=J2_2): 4
4. Pin Description(J1_3): 4
5. Electrical Characteristics 5
6. Controller Information 6
7. Font Characteristic 9
8. Reliability Test Conditions 10
9. Inspection Criterion 10
10. Handling Precautions 18
11. Precaution for Use 19
12. Packing Specification 20
13. Mechanical Drawing (Unit mm, Un-tolerated ±0.3mm) 21

DATE	DESCRIPTION
2018-11-30	First release



1. DISPLAY CHARACTERISTICS

Item	Contents	Note
Resolution(H*V)	320×240 Dots	
Colors	Mono TFT display	
Font & Background Color	Font color and background color can be customized as needed	Configurable 8 display modes
Active area (L*W)	115.2 mm(L)×86.4 mm(W)	
Viewing area (L*W)	117.56 mm(L)×88.62 mm(W)	
Module size (L*W*H)	160 mm(L)×109 mm(W)x 11.4(H)	
Back light type	LED	
B/L brightness	400nit	
Touch Panel Type	Without	
Controller IC	UCi8835	
Viewing Direction	6 o' clock	
Contrast Ratio	300(typ.)	

2. Pin Description(J1=J1_1):

Pin No.	Symbol	External Connection	Function Description
1	VSS	Power Supply	GND
2	VDD	Power Supply	Power supply
3	NC	/	No connection
4	/WR	MPU	(8080:) Write Control or (6800:) Read/Write Control.
5	/RD	MPU	(8080)Read Control or (6800:) Enable.
6	/CS	MPU	Active LOW Chip Select signal
7	A0(=RS=C/D)	MPU	Command/Data Select.
8	/RST	MPU	Active LOW Reset signal
9~16	DB0~DB7	MPU	8-bit bidirectional data bus
17	NC/LED PWM	NC/MPU	Backlight enable signal, 1=On, 0=Off
18	NC	/	No connection
19	NC/LED PWM	NC/MPU	Backlight enable signal, 1=On, 0=Off
20	NC	/	No connection

Mode	A0	$\overline{RD}$	$\overline{WR}$	Function
8080	0	0	1	Status-Flag-Read
	0	1	0	Display-Data-and-Parameter-Write
	1	0	1	Display-Data-and-Cursor-Address-Read
	1	1	0	Command-Write
	A0	R/$\overline{W}$	E	Function
6800	0	0	1	Display-Data-and-Parameter-Write
	0	1	1	Status-Flag-Read
	1	0	1	Command-Write
	1	1	1	Display-Data-and-Cursor-Address-Read

3. Pin Description(J2=J2_2):

Pin No.	Symbol	External Connection	Function Description
1	D0	MPU	Data for LCD Driver
2	D1	MPU	Data for LCD Driver
3	D2	MPU	Data for LCD Driver
4	D3	MPU	Data for LCD Driver
5	DISP	MPU	Display on/off signal
6	FLM	MPU	Fram signal
7	M	MPU	AC drive signal
8	LP	MPU	Latch Pulse
9	CP	MPU	Data shift clock
10	VDD	Power Supply	Power supply
11	VSS	Power Supply	GND
12	NC	/	No connection
13	NC	/	No connection
14	FG		Frame ground

4. Pin Description(J1_3):

Pin No.	Symbol	External Connection	Function Description
1	VSS	Power Supply	GND
2	VDD	Power Supply	Power supply
3	NC	/	No connection
4	A0(=RS=C/D)	MPU	Command/Data Select.
5	/WR	MPU	(8080:) Write Control or (6800:) Read/Write Control.
6	/RD	MPU	(8080)Read Control or (6800:) Enable.
7~14	DB0~DB7	MPU	8-bit bidirectional data bus
15	/CS	MPU	Active LOW Chip Select signal
16	/RST	MPU	Active LOW Reset signal
17	NC	/	No connection
18	SEL1	MPU	MCU Interface Select. The UCi8835 series supports both 8080 family processors (such as the 8085 and Z80®) and 6800 family processors (such as the 6802 and 6809). SEL1=0=8080 family ; SEL1=1=6800 family ;
19	FGND	Power Supply	GND
20	NC	/	No connection

Mode	A0	$\overline{RD}$	$\overline{WR}$	Function
8080	0	0	1	Status-Flag-Read
	0	1	0	Display-Data-and-Parameter-Write
	1	0	1	Display-Data-and-Cursor-Address-Read
	1	1	0	Command-Write
	A0	R/$\overline{W}$	E	Function
6800	0	0	1	Display-Data-and-Parameter-Write
	0	1	1	Status-Flag-Read
	1	0	1	Command-Write
	1	1	1	Display-Data-and-Cursor-Address-Read

5. Electrical Characteristics

Item	Symbol	Condition	Min.	Typ.	Max.	Unit
Operating Temperature Range	Top	Absolute Max	-20	-	+70	^{0}C
Storage Temperature Range	Tst	Absolute Max	-30	-	+80	^{0}C
Supply Voltage	VDD		4.5	5.0	5.5	V
Input High Voltage	VIH		0.8*VDD	-	VDD	V
Input Low Voltage	VIL		0	-	0.2*VDD	V
Supply Current	IVCI		-	450	-	mA
Power Consumption	PLCM		-	2250	-	mW

6. Controller Information

6.1 CONTROL AND DISPLAY INSTRUCTION

COMMAND TABLE

C/D: 1:Command / 0:Data W/R: 0:Write Cycle / 1: Read Cycle D7-D0: –:Don't Care

No.	Command	C/D	W/R	D7	D6	D5	D4	D3	D2	D1	D0	Action	Value
1.	System Set	1	0	0	1	0	0	0	0	0	0	Initialize device and display	40h
		0	0	0	0	IV	1	W/S	M2	M1	M0		
		0	0	WF	0	0	0	0	FX2	FX1	FX0		
		0	0	0	0	0	0	FY3	FY2	FY1	FY0		
		0	0	C/R [7:0]									
		0	0	TC/R [7:0]									
		0	0	L/F [7:0]									
		0	0	APL [7:0]									
		0	0	APH [7:0]									
2.	MWRITE	1	0	0	1	0	0	0	0	1	0	Write to display memory	42h
		0	0	1 : N								Write Display data byte (n times)	
3.	MREAD	1	0	0	1	0	0	0	0	1	1	Read from display memory	43h
		0	1	1 : N								Read Display data byte (n times)	
4.	Scroll	1	0	0	1	0	0	0	1	0	0	Set display regions	44h
		0	0	SAD1 [7:0]								SAD1L	
		0	0	SAD1 [15:8]								SAD1H	
		0	0	SL1 [7:0]								SL1	0~255
		0	0	SAD2 [7:0]								SAD2L	
		0	0	SAD2 [15:8]								SAD2H	
		0	0	SL2 [7:0]								SL2	0~255
		0	0	SAD3 [7:0]								SAD3L	
		0	0	SAD3 [15:8]								SAD3H	
		0	0	SAD4 [7:0]								SAD4L	
		0	0	SAD4 [15:8]								SAD4H	
5.	CSRW	1	0	0	1	0	0	0	1	1	0	Set cursor Address	46h
		0	0	CSR [7:0]								Write CSRL	
		0	0	CSR [15:8]								Write CSRH	
6.	CSRR	1	0	0	1	0	0	0	1	1	1	Read cursor address	47h
		0	1	CSR [7:0]								Read CSRL	
		0	1	CSR [15:8]								Read CSRH	
7.	CSRDIR	1	0	0	1	0	0	1	1	CD1	CD0	Set direction of cursor move	4C~4Fh
8.	Sleep IN	1	0	0	1	0	1	0	0	1	1	Enter standby mode	53h
9.	Display ON/OFF	1	0	0	1	0	1	1	0	0	D	Enable/Disable display	58/59h
		0	0	FP5	FP4	FP3	FP2	FP1	FP0	FC1	FC0		
10.	HDOT SCR	1	0	0	1	0	1	1	0	1	0	Set Horizontal Scroll position	5Ah
		0	0	0	0	0	0	0	D2	D1	D0	D[2:0]	0~7
11.	OVLAY	1	0	0	1	0	1	1	0	1	1	Set display overlay format	5Bh
		0	0	0	0	0	OV	DM2	DM1	MX1	MX0		
12.	CGRAM Address	1	0	0	1	0	1	1	1	0	0	Set Start address of character generator RAM	5Ch
		0	0	SAG [7:0]								SAGL	
		0	0	SAG [15:8]								SAGH	
13.	CSRFORM	1	0	0	1	0	1	1	1	0	1	Set cursor type	5Dh
		0	0	0	0	0	0	CRX3	CRX2	CRX1	CRX0		
		0	0	CM	0	0	0	CRY3	CRY2	CRY1	CRY0		

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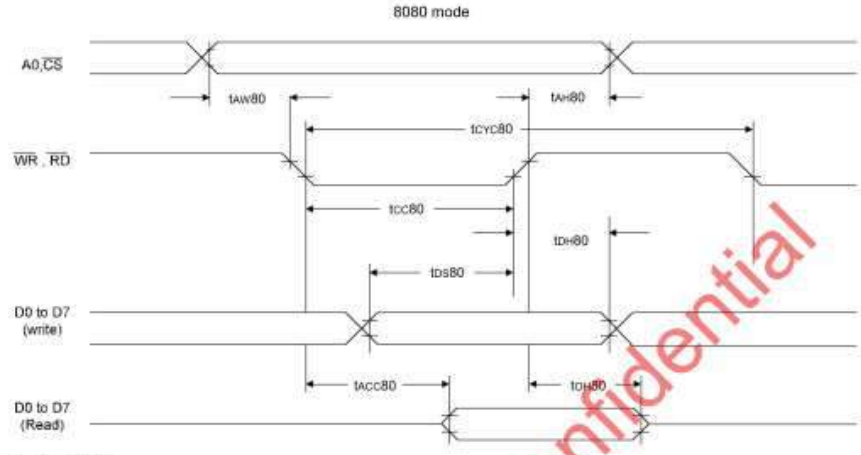
6.2 Interface Timing Diagram and Timing Characteristics



(T_A=–20 ~ 75°C)

Symbol	Signal	Parameter	Condition	V_{DD}=4.5~5.5V		V_{DD}=2.7~4.5V		Unit
				Min.	Max.	Min.	Max.	
t_{AW80}	A0, $\overline{CS}$	Address setup time	C_L=100pF	0	–	0	–	nS
t_{AH80}		Address hold time		10	–	10	–	nS
t_{CYC80}	$\overline{WR}$, $\overline{RD}$	System cycle time		(Note)	–	(Note)	–	nS
t_{CC80}		Strobe pulse width		120	–	150	–	nS
t_{DS80}	D7~D0	Data setup time		120	–	120	–	nS
t_{DH80}		Data hold time		5	–	5	–	nS
t_{ACC80}		Access time		–	50	–	80	nS
t_{OH80}		Output disable time		10	50	10	55	nS

Note:

For memory control and system control commands: $t_{CYC80} = 2t_C + t_{CC} + t_{CEA} + 75 > t_{ACV} + 245$

For all other commands: $t_{CYC80} = 4t_C + t_{CC} + 30$

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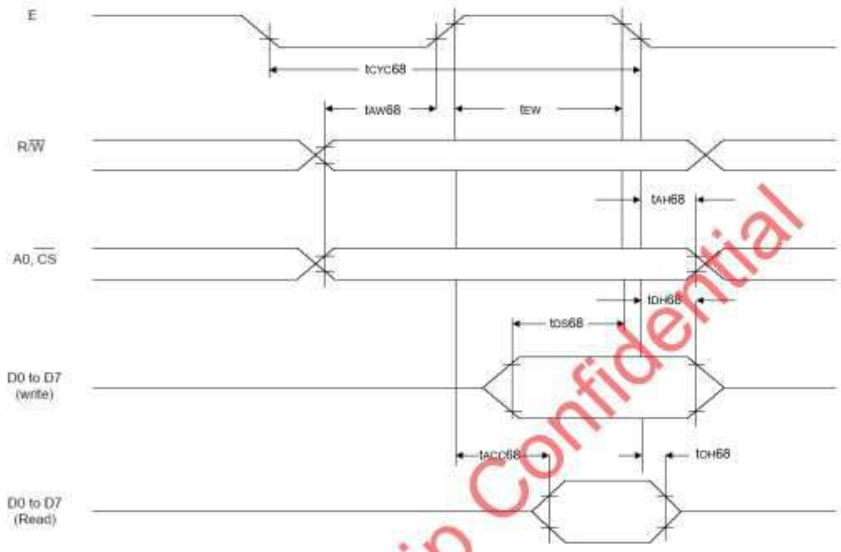
6800 mode



(TA=–20 ~ 75 °C, Condition: CL=100pF)

Symbol	Signal	Parameter	VDD=4.5~5.5V		VDD=2.7~4.5V		Unit
			Min.	Max.	Min.	Max.	
tAW68	A0, CS, R/(W)	Address setup time	0	–	10	–	nS
tAH68		Address hold time	10	–	0	–	nS
tCYC68		System cycle time	(Note)	–	(Note)	–	nS
tDS68	D7~D0	Data setup time	100	–	120	–	nS
tDH68		Data hold time	0	–	0	–	nS
tACC68		Access time	–	85	–	130	nS
tOH68		Output disable time	10	50	10	75	nS
tEW68	E	Enable pulse width	120	–	150	–	nS

Note:

For memory control and system control commands: tCYC68 = 2tC + tEW + tCEA + 75 > tACV + 245

For all other commands: tCYC68 = 4tC + tEW + 30

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7. Font Characteristic

Internal Character Generator Font

Figure 53: On-chip Character Set

Note: The shaded positions indicate characters that have the whole 6 x 8 bitmap blackened.

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8. Reliability Test Conditions

No.	Test item	Test condition	Inspection after test
11.1	High temperature storage	80±2°C/120 hours	Note 1,2
11.2	Low temperature storage	-30±2°C/120 hours	
11.3	High temperature operating	70±2°C/120 hours	
11.4	Low temperature operating	-20±2°C/120 hours	
11.5	Temperature cycle	-20±2°C~25°C~70±2°C*10cycles (30min.) (5min.) (30min.)	
11.6	Damp proof test	60°C*90% RH/96 hours	
11.7	Vibration test	Frequency : 10Hz~55Hz~10Hz Amplitude : 1.5mm , X , Y , Z direction for total 3hours (Packing condition)	
11.8	Dropping test	Drop to the ground from 1m height, one time, every side of carton. (Packing condition)	
11.9	ESD test	Voltage : ±800V R : 330Ω C : 150pF Air discharge, 1 time	
Remark : Note 1: No condensation to be observed. Note 2: Conducted after 4 hours of storage at 25^{0}C, 0%RH.			

9. INSPECTION CRITERION

9.1 Objective

The LCM test criterion are set to formalize LCM quality standards for NEWPANELTECH with reference to those of the customer for inspection, release and acceptance of finished LCM products in order to guarantee the quality of LCM products required by the customer.

9.2. Scope

The criterion is applicable to all the LCM products manufactured by NEWPANELTECH.

9.3. Equipment for Inspection

Electrical tester, electrical testing machines, vernier calipers, microscopes, magnifiers, anti-static wrist straps, finger cots, labels, tri-phase cold and hot shock machine, constant temperature and humidity chamber, backlight table, ovens for high-low temperature experiments, refrigerators, constant voltage power supply (DC), desk Lamps, etc.

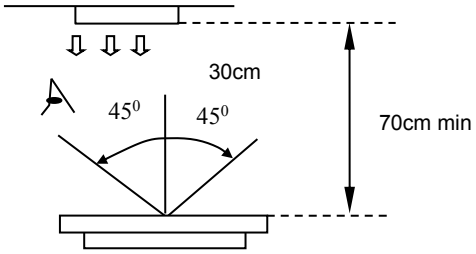
9.4. Sampling Plan and Reference Standards

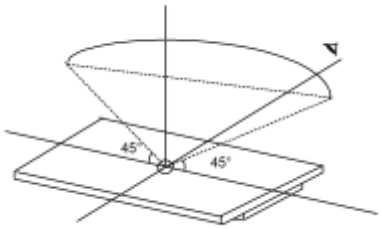
9.4.1 Sampling plan :
Refer to National Standard GB/T 2828.1---2012/ISO2859-1:1999, level II of normal levels :
Major defect: AQL 0.4
Minor defect: AQL 1.0
9.4.2 GB/T 2828.1---2012/ISO2859-1:1999 Sampling check procedure in count
9.4.3 GB/T 18910. Standard for LCM parts
9.4.4 GB/T24213-2008 Basic Environmental Test Procedures for Electrical and Electronic Products
9.4.5 IPC-A-610E Acceptability of Electronic Assemblies

9.5. Inspection Conditions and Inspection Reference

9.5.1 Cosmetic inspection: shall be done normally at 23±5℃ of the ambient temperature and 45~75%RH of relative humidity, under the ambient luminance between 500lux~1000lux and at the distance of 30cm apart between the inspector's eyes and the LCD panel and normally in reflected light. For backlight LCM, cosmetic inspection shall be done under the ambient luminance less than 100lux with the backlight on.

9.5.2 The LCM shall be tested at the angle of 45°left and right and 0-45° top and bottom as the following picture showing:





9.5.3 Definition of viewing area(VA)

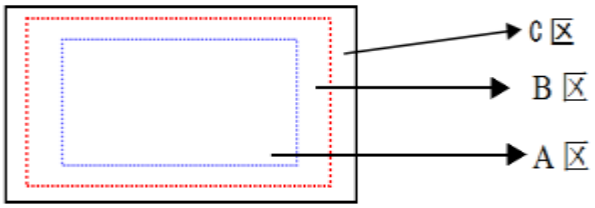
A area : Active area(AA area)

B area : Viewing area(VA area)

C area : Non-viewing area(not viewing after customer assembly)

If there is any appearance viewing defect which do not affect product quality and customer assembly in C area, it's accepted in generally.

The criteria apply to A and B area except chipping and crack.



9.5.4 Inspection with naked eyes(exclusive of the inspection of the physical dimensions of defects carried out with magnifiers)

9.5.5 ND card use method(refer to right conner image) and scope: Multi-bright dot; Mura(Black/Gray pattern uneven); dark line and so on.

9.5.6 Undefined items or other special items, refer to mutual agreement and limited sample.If criterion does not match product specifications/ technical requirement, both should be subject to special inspection criterion agreed by customer.

9.6. Defects and Acceptance Standards

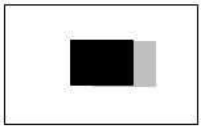
9.6.1 Electrical properties test

9.6.1.1 Test voltage(V) : Refer to the instruction of testers and the product specification or drawing and the display content and parameters and display effects shall conform to the product specification and drawing.

9.6.1.2 Current Consumption(I) : Refer to approved product specifications or drawings.

9.6.1.3 Function items(Defect category : MA.)

No.	Defects	Descriptions	Pictures	Inspection method/tools	Defect category
9.6.1.3.1	No display /reaction	shows no picture/display in normal connected situation.		Naked eyes/ testers	MA.

9.6.1.3.2	Missing segment	Shows missing lines in normal display		Naked eyes/ testers	MA.
9.6.1.3.3	Dark line	Only visible on gray pattern, 1 or more vertical/horizontal lines:5%ND,not visible,OK	/	Naked eyes/ testers	MA.
9.6.1.3.4	POL angle defect	Not accepted		Naked eyes/ testers	MA.
9.6.1.3.5	Image retention (sticking)	Chess pattern stays for 30mins and change to 50% gray pattern,disappear time <10s, OK; if time>10s, NG		Naked eyes/ testers	MA.
9.6.1.3.6	Flicker	Refer to limit sample if essential or flicker value<-30dB(measured by CA310A); OK		Naked eyes/ CA310A	MA.
9.6.1.3.7	Display abnormal	Not accepted		Naked eyes/ testers	MA.
9.6.1.3.8	Cross-talk	Refer to limited sample		Naked eyes/ limited sample	MA.
9.6.1.3.9	Display dim/bright	Refer to limited sample	/	Naked eyes/ limited sample	MA.
9.6.1.3.10	Contrast	Refer to limited sample	/	Naked eyes/ limited sample	MA.
9.6.1.3.11	Huge current	Out of spec, not accepted	/	Ammeter	MA.
9.6.1.3.12	TP function defect	Not accepted	/	Naked eyes/ Touch/ test program	MA.

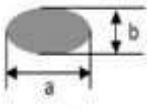
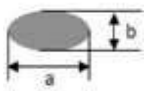
9.6.2 LCD dot/line defect

9.6.2.1 LCD pixel dot defect(defect category : MI.)

Item	Inspection criterion		
Size	S<5”	5”≤S<10”	10”≤S<15”
Color pixel dot defect(RGB dot)	1	2	2
2 connected bright dot	0	1	1
3 connected bright dot or more	0	0	1
Bright dot quantity	1	2	3
Random dark dot quantity	2	3	4
2 connected dark dot	1	1	2

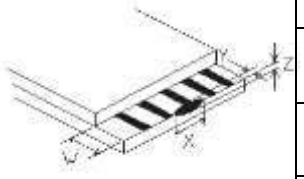
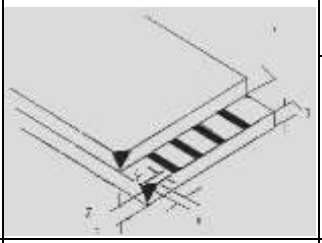
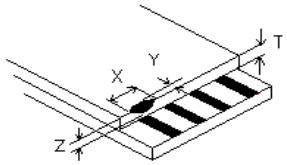
Item	Inspection criterion		
3 connected dark dot or more	0	0	0
Dark dot quantity	3	4	5
Multi-bright dot	ND 3%hidden, OK		
Remark: 2 bright dots distance DS≥15mm 2 dark dots distance DS≥5mm 1) Bright dot: Power on LCM and RGB dot in black display 2) Dark dot: Power on LCM and gray or black dot in RGB display 3) Multi-bright dot: Power on LCM and fluorescent tiny dot in black display(only visible in black display)			

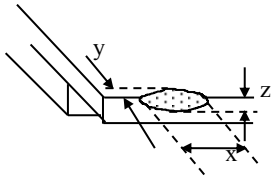
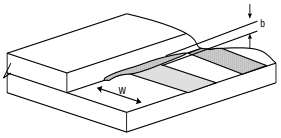
9.6.2.2 LCD appearance dot defect (defect category : MI.)

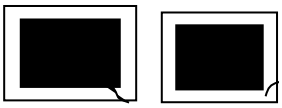
No.	Item	Inspection criterion				Picture	Inspection method/tools
		Size	S<5”	5”≤S<10”	10”≤S<15”		
9.6.2.2.1	Dot defect (black dot, white dot)	D≤0.15	Not count	Not count	D≤0.2mm Not count	 D=(a+b)/2	Naked eyes /film card /magnifier
		0.15<D≤0.25	3	3			
		0.25<D≤0.30	1	2	0.2~0.35mm Q’ty ≤ 4		
		0.30<D≤0.35	0	1			
		0.35<D≤0.50	0	0	1		
		D>0.5	0	0	0		
		Remark : D≤0.15mm, not count.Multi-dot as bulk is not accepted. Count dot quantity≤ 5 2 round dots or linear dots in 1 cm is judged as multi-dot.					
9.6.2.2.2	Line defect (visible when power on)	Length (mm)	Width (mm)	S<5”	5”≤S<10”	10”≤S<15”		Naked eyes /film card /magnifier
		Not count	W≤0.03	Accepted	Accepted	Accepted		
		L≤5	0.03≤W <0.05	3	3	Not count		
		L≤5	0.05≤W <0.08	0	1	3		
		L≤8	0.05≤W <0.08	0	0	1		
		L>8	W>0.08	0				
		Remark : Invisible when power on,only visible in special angle against light, show as watermark/folding/scratch but can not be touched, no control or refer to keeping sample.					
9.6.2.2.3	Polarizer convex-concave dot defect, polarizer bubble defect	Size(mm)		S<5”	5”≤S<10”	10”≤S<15”		Naked eyes /film card /magnifier
		D≤0.20		Not count	Not count	Not count		
		0.20<D≤0.5		2	2	3		
		0.50<D≤0.8		0	1			
		0.8<D≤1.5		0	0	1		
		D>1.5mm		0	0	0		

9.6.3 Chipping defect

No.	Item	Accepted criterion(mm)	MA.	MI.

<table>
<tr><td rowspan="5">9.6.3.1</td><td rowspan="5">ITO conductive side
  </td><td>X</td><td>/</td><td>≤1/8L</td><td>/</td><td></td><td rowspan="5">√</td></tr>
<tr><td>Y</td><td>Y≤1/6W</td><td>1/6W <Y≤1/4W</td><td>1/4W <Y</td><td></td></tr>
<tr><td>Accept</td><td>2</td><td>2</td><td>0</td><td></td></tr>
<tr><td colspan="4"></td><td></td></tr>
<tr><td colspan="4"></td><td></td></tr>
<tr><td rowspan="5">9.6.3.2</td><td rowspan="2">Corner chipping
(ITO pins position)</td><td>X</td><td>/</td><td>≤1/6L</td><td>/</td><td></td><td rowspan="2">√</td></tr>
<tr><td>Y</td><td>Y≤1/2W</td><td>1/2W <Y≤W</td><td>W <Y</td><td></td></tr>
<tr><td rowspan="3">  </td><td>Accept</td><td>2</td><td>1</td><td>0</td><td></td><td></td></tr>
<tr><td colspan="4">Corner chipping occurred in sealed edge position as per 6.3.3; at the same time it should not enter into black border of the frame and the corner chipping effect the electric connection position perform as per 6.3.1.</td><td></td><td></td></tr>
<tr><td colspan="4"></td><td></td></tr>
<tr><td rowspan="6">9.6.3.3</td><td rowspan="6">Chipping in sealed area (outside chipping)
 

Chipping in sealed area (inside chipping)</td><td>X</td><td>/</td><td>≤1/8L</td><td>/</td><td></td><td rowspan="6">√</td></tr>
<tr><td>Y(outside chipping)</td><td rowspan="2">Not enter into sealant</td><td>Enter Y≤H</td><td>H<Y</td><td></td></tr>
<tr><td>Y(inside chipping)</td><td>Enter Y≤1/2H</td><td>1/2H<Y</td><td></td></tr>
<tr><td>Z</td><td>≤T</td><td>≤1/2T</td><td>/</td><td></td></tr>
<tr><td>Accept</td><td>2</td><td>1</td><td>0</td><td></td></tr>
<tr><td colspan="4">The standards of inner and outer chipping on edge sealing area are same. When the chipping occurred in the opposite of stage, Y as per the chipping on the non-conduction side standard in 6.3.1</td><td></td></tr>
<tr><td rowspan="4">9.6.3.4</td><td rowspan="4">Conductive side
(back side chipping)
  </td><td>X</td><td>/</td><td>≤1/6L</td><td>/</td><td></td><td rowspan="4">√</td></tr>
<tr><td>Y</td><td>Y≤1/3W</td><td>1/3W <Y≤2/3W</td><td>2/3W <Y</td><td></td></tr>
<tr><td>Accept</td><td>2</td><td>2</td><td>0</td><td></td></tr>
<tr><td colspan="4">Chipping into ITO side, refer to 6.3.1</td><td></td><td></td></tr>
<tr><td rowspan="5">9.6.3.5</td><td rowspan="5">Protruding LCD poor cutting and LCD burrs
  </td><td>X</td><td>/</td><td>≤1/8L</td><td>/</td><td></td><td rowspan="5">√</td></tr>
<tr><td>Y</td><td>≤1/6W</td><td>1/6W <Y≤1/5W</td><td>1/5W <Y</td><td></td></tr>
<tr><td>Z</td><td>/</td><td>/</td><td>/</td><td></td></tr>
<tr><td>Accept</td><td>1</td><td>1</td><td>1</td><td></td></tr>
<tr><td colspan="4">The outside protruding control as per the tolerance of drawing.</td><td></td><td></td></tr>
</table>

9.6.3.6	Crack 	Not allow to occur cracks without direction; the crack expand to inside is NG, but to outside is OK (confirmed as per the damaged standard)		√

Remark :

X means the length of chipping;

Y means the width;

Z means the thickness;

W means the step width of the two glasses;

H means the distance from the glass edge to the sealant inner edge;

T means glass thickness.

9.6.4 Backlight components

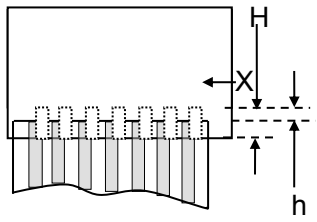
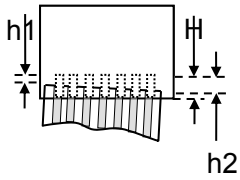
No.	Item	Description	Accepted criterion	MA.	MI.
9.6.4.1	No backlight wrong Color	/	Rejected	√	
9.6.4.2	Color deviation	When powered on, the LCD color differs from its sample and found that the color not conforming to the drawing after testing.	Refer to sample and drawing		√
9.6.4.3	Brightness deviation	When powered on, the LCD brightness differs from its sample and is found after testing not conforming to the drawing; or if it conforms to the drawing but the brightness over ±40% than its typical value.	Refer to sample and drawing		√
9.6.4.4	Uneven brightness	Uneven on the same LCD and out of the specification of the drawing. The no specification evenness= (the max value-the min value)/ mean value< 70%.	Refer to sample and drawing		√
9.6.4.5	Spot/line/ scratch	When power on, it has dirty spot, scratches and so on spot and line defects.	Refer to 6.2.2		√

9.6.5 Metal frame (Metal Bezel)

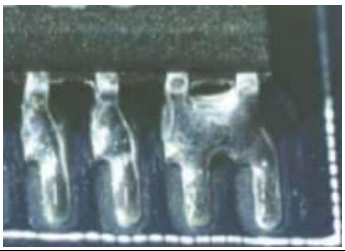
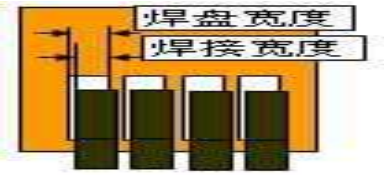
No.	Item	Description	Accepted criterion	MA.	MI.
9.6.5.1	Material & surface treatment	Metal frame/surface treatment do not conform to the specifications.	Rejected	√	
9.6.5.2	Tab twist Unconformity /Tab not twisted	Wrong twist method or direction and twist tabs are not twisted as required.	Rejected	√	
9.6.5.3	Bezel paint loss	1.Front surface : Paint peel off and scratch to the bottom Dot:D≤0.5mm, exceeds 3; Line:L≤3.0mm,W≤0.05mm exceeds 2;	Rejected		√
9.6.5.4	Bezel scratch				√

9.6.5.5	Painting peel off, discoloration, dent, and scratch	2.Front dent, air bubble and side with paint peeling off scratch to the bottom Dot: D≤1.0mm, exceeds 3; Line:L≤3.0mm,W≤0.05mm, exceeds 2;			√
9.6.5.6	Burr	Burr(s) on metal bezel is so long as to get into viewing area.	Rejected		√

9.6.6 FPC

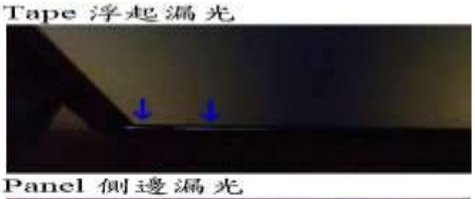
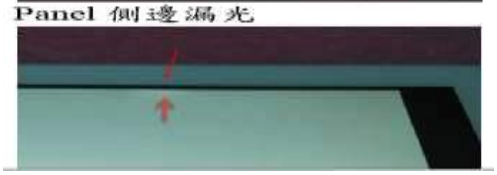
No.	Item	Description	Accepted criterion	MA.	MI.
9.6.6.1	Model &P/N	Material model & P/N	Keep the same with drawing and technical requirement	√	
9.6.6.2	Dimension/ position	Dimension in drawing spec  Remark: H=ITO pin length f=FPC width W=ITO pin width	f≤1/3w, h ≤1/3H, dimension in drawing spec-> OK Conductive material and ITO/PDA connective area must over than 1/2. Entire dimension must be in spec tolerance.  		√
9.6.6.3	FPC appearance	Hot pressing material get broken, folding line open; FPC golden finger oxidate, broken ,scratch ,foreign material which cause line short	Broken length<2mm; FPC line is OK- > Accepted Crack and line broken->Rejected		√
9.6.6.4	FPC burr	Burr near FPC edge area	When cover line and burr length ≤1.0mm->Accepted		√
9.6.6.5	FPC falling off	FPC bonding area falling off ; silica gel breaking	Rejected		√
9.6.6.6	Sealant missing ITO line	Sealant is not covered all ITO line	Rejected	√	
9.6.6.7	Missing sealant	No sealant	Rejected	√	
9.6.6.8	Sealant	Sealant height ->product total height	Rejected	√	

9.6.7 SMT

No.	Item	Description	Accepted criterion	MA.	MI.
9.6.7.1	Soldering bridge	Solder between adjacent pads and components 	Rejected		√
9.6.7.2	Solder ball/splash	Solder ball/tin dross causing short circuit at the solder point. There are active solder ball and splash.	Rejected		√
9.6.7.3	Soldering excursion	Soldering slant > 1/3 soldering pad 	Rejected		√
9.6.7.4	Component wrong attaching	Component on PCB differs with drawing: wrong one, extra one,lack one,opposite polarity	Rejected	√	
		JUMP short circuit on PCB: extra soldering ,lack soldering.	Rejected	√	
9.6.7.5	Component falling off	Soldering but component is missing	Rejected	√	
9.6.7.6	Wrong component	Component model/spec differs from product specification	Rejected	√	

9.6.8 General Appearance

No.	Item	Description	Accepted criterion	MA.	MI.
9.6.8.1	Dimension	According to drawing	Accepted	√	
9.6.8.2	Surface stain	Defect mark or label are not removed residual glue, and finger print,etc;	Rejected		√
9.6.8.3	Assembly foreign material	Dot/linear stain after assembly backlight and diffuse film TP assembly fogy stain	Invisible when power on->OK Refer to 6.2.2 dot/line spec		√
9.6.8.4	Mixture	Different model product in the same shipment	Rejected	√	
9.6.8.5	Product mark	Missing, unclear, incorrect, or misplaced part	Rejected		√
9.6.8.6	Componen t mark	Silk screen mark clear, resistance measured value in spec	Accepted (Refer to customer special requirement)		√
9.6.8.7	Newton's rings	Area<1/6 screen area quantity≤1	Accepted		√

9.6.8.8	Mura	1.In black display ND 3% invisible ->OK; visible->NG 2.Naked eyes inspection RGB display invisible Black display, area<1/4 screen area	Refer to limited sample 		√
9.6.8.9	Light leak	1.LCD edge(near backlight) shadow by LCD lamps irregular illuminate 2.Judge in black/white/gray display (slight leaky is yellowish,greenish, blueish ->NG); Tape 浮起漏光  Panel 側邊漏光 	Refer to limited sample		√
9.6.8.10	Polarizer	1.Polarizer slant.Cover VA and not over LCD edge 2.No unmovable stain or finger print in polarizer VA 3.Bubble/warped but not enter VA	Accepted		√
9.6.8.11	TP defect	1.TP crack 2.TP stain(fogy& unremovable) 3.TP glue overflow to VA	Rejected		√

Remark :
Anything which is not clearly defined in 6.5~6.8 should refer to IPC-A-610E.Consumer Electronics, Non-consumer Electronics refer to Ⅰgrade and Industrial,Automobile refer to Ⅱgrade.

9.7 Others
Items not specified in this document or released on compromise should be inspected with reference to mutual agreement and limit samples.

10. HANDLING PRECAUTIONS
10.1 Mounting method
The LCD module consists of two thin glass plates with polarizes which easily be damaged. And since the module in so constructed as to be fixed by utilizing fitting holes in the printed circuit board.
Extreme care should be needed when handling the LCD modules.
10.2 Caution of LCD handling and cleaning
When cleaning the display surface, Use soft cloth with solvent [recommended below] and wipe lightly :
●.Isopropyl alcohol
●.Ethyl alcohol

Do not wipe the display surface with dry or hard materials that will damage the polarizer surface.
Do not use the following solvent :
●.Water
●.Aromatics
Do not wipe ITO pad area with the dry or hard materials that will damage the ITO patterns
Do not use the following solvent on the pad or prevent it from being contaminated :
●.Soldering flux
●.Chlorine (Cl) , Sulfur (S)
If goods were sent without being silicon coated on the pad, ITO patterns could be damaged due to the corrosion as time goes on.
If ITO corrosion happen by miss-handling or using some materials such as Chlorine (Cl), Sulfur (S) from customer, Responsibility is on customer.

10.3 Caution against static charge

The LCD module use C-MOS LSI drivers, so we recommended that you :
Connect any unused input terminal to Vdd or Vss, do not input any signals before power is turned on, and ground your body, work/assembly areas, assembly equipment to protect against static electricity.

10.4 Packing

Module employ LCD elements and must be treated as such.
●.Avoid intense shock and falls from a height.
●.To prevent modules from degradation, do not operate or store them exposed direct to sunshine or high temperature/humidity.

10.5 Caution for operation

●.It is an indispensable condition to drive LCD's within the specified voltage limit since the higher voltage then the limit cause the shorter LCD life.
●.An electrochemical reaction due to direct current causes LCD's undesirable deterioration, so that the use of direct current drive should be avoided.
●.Response time will be extremely delayed at lower temperature then the operating temperature range and on the other hand at higher temperature LCD's how dark color in them. However those phenomena do not mean malfunction or out of order with LCD's, which will come back in the specified operation temperature.
●.If the display area is pushed hard during operation, some font will be abnormally displayed but it resumes normal condition after turning off once.
●.A slight dew depositing on terminals is a cause for electro-chemical reaction resulting in terminal open circuit.
●.Usage under the maximum operating temperature, 50%Rh or less is required.
●.When fixed patterns are displayed for a long time,remnant image is likely to occur.

10.6 Storage

In the case of storing for a long period of time for instance, for years for the purpose or replacement use, the following ways are recommended.
●.Storing in an ambient temperature 10°C to 30°C, and in a relative humidity of 45% to 75%. Don't expose to sunlight or fluorescent light.
●.Storing in a polyethylene bag with the opening sealed so as not to enter fresh air outside in it . And with no desiccant.
●.Placing in a dark place where neither exposure to direct sunlight nor light's keeping the storage temperature range.
●.Storing with no touch on polarizer surface by the anything else.
It is recommended to store them as they have been contained in the inner container at the time of delivery from us.

10.7 Safety

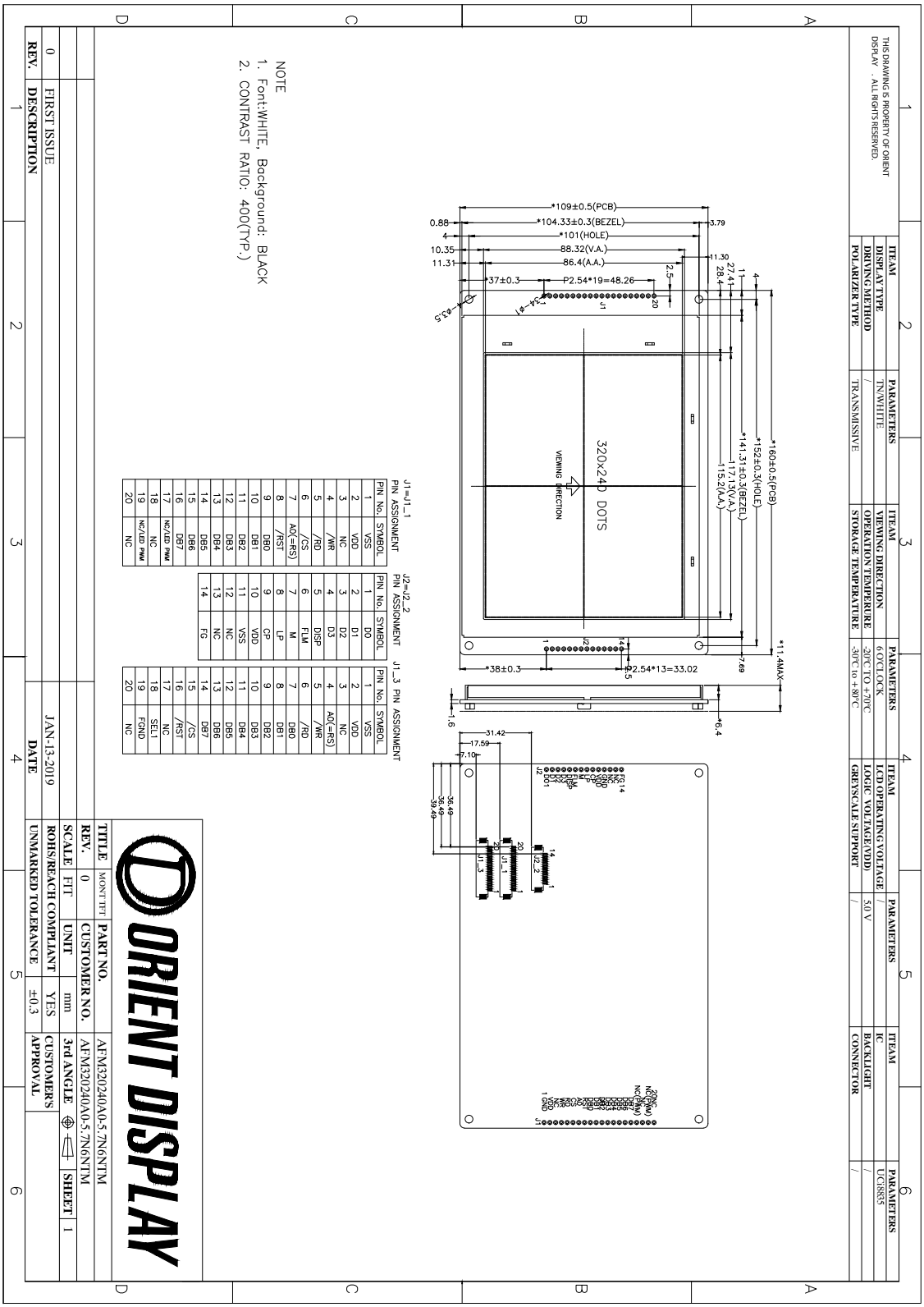
●.It is recommendable to crash damaged or unnecessary LCD's into pieces and wash off liquid crystal by either of solvents such as acetone and ethanol, which should be burned up later.
●.When any liquid leaked out of a damaged glass cell comes in contact with your hands, please wash it off well with soap and water.

11. PRECAUTION FOR USE

11.1 A limit sample should be provided by the both parties on an occasion when the both parties agreed its necessity. Judgment by a limit sample shall take effect after the limit sample has been established and confirmed by the both parties.
11.2 On the following occasions, the handing of problem should be decided through discussion and agreement between responsible of the both parties.

●.When a question is arisen in this specification.
●.When a new problem is arisen which is not specified in this specifications.
●.When an inspection specifications change or operating condition change in customer is reported to NEWPANELTECH, and some problem is arisen in this specification due to the change.
●.When a new problem is arisen at the customer's operating set for sample evaluation in the customer site.

12. PACKING SPECIFICATION

---TBD

13. Mechanical Drawing (Unit mm, Un-tolerated ±0.3mm)